· · · ·	J.S. PAT	03-	17-2003	Atty Docket: 50626.4
Form PTO-1595 1-31-92 3 - 14-6	RECOF		390973	U.S. DEPARTMENT OF CC Patent and Traden
To the Honorable Commissioner of Patents and Tradema	arks: Please record t	he attached original d	ocuments or copy thereof.	
Name of conveying party(ies): Chun Ho FAN, Kwok Cheung TSANG, and William Lap Keung CHOW Additional name(s) of conveying party(ies) attached? ☐ yes ⊠no		 Name and address of receiving party(ies): (2a.) Name: ASAT LTD. Address: QPL industrial Building, 14th Floor, 138 Texaco Tsuen Wan, New Territories Hong Kong 		
 3. Name of Conveyance: Assignment			(2b.) Name Address: Additional name(s) & address(es) attached? □yes ⊠no	
Execution Date: December 2, 2002				
4. Application number(s) or patent numb			n date of the application is:	
A. Patent Application No.(s) 10/307,279		B. Patent No.(s)		
	Additic	onal numbers att	ached □ yes •□no	
document should be mailed: Name: <u>Joseph R. Keating, Esq.</u> Internal Address: <u>KEATING & BENI</u> Street Address: <u>10400 Eaton Place</u> City: <u>Fairfax</u> <u>State: VA</u> ZIP 2	e, Suite 312		 7. Total fee (37 CFR 3.41): Enclosed Authorized to be charged Form (PTO-2038) Authorized to be charged 8. Deposit account number: 5 	to credit card with Orditi Card P to deposit account
	DC		THIS SPACE	
9. Statement and signature. To the best of my knowledge and belief, th Joseph R. Keating, Reg. No. 37,368 Name of Person Signing 7/2003 LINELLER 00000048 10307279	\frown	rmation is true a AMA Signat	nd correct and any attached copy	<u>March 7, 2003</u> Date
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Mail documents to be recorded with requir	ed cover sheet	sistant Commis Box As:	sioner for Patents signment n, D.C. 20231	

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WORLDWIDE ASSIGNMENT

WHEREAS, WE, Chun Ho FAN; Kwok Cheung TSANG; William Lap

Keung CHOW residing at, respectively, Flt. E., 27/F., Blk. 3, Lido Garden, Sham Tseng, Hong Kong; Flt. A, 16/F, Block 8, Avon Park, Fanling, N.T., Hong Kong; and Flat D, 35/F., Tower 10, Park Avenue, Kowloon, Hong Kong, have invented certain new and useful improvements in an invention entitled **THIN BALL GRID ARRAY PACKAGE** for which an application for United States Letters Patent will be filed; and

WHEREAS, ASAT LTD., a company organized and existing under the laws of the city of Hong Kong, having a place of business at QPL Industrial Building, 14th Floor, 138 Texaco Road, Tsuen Wan, New Territories Hong Kong is desirous of acquiring the full and exclusive right, title and interest in and to said application inclusive of any and all priority rights derived therefrom and the inventions therein disclosed, and in and to all Letters Patent, both United States and foreign, to be granted for said inventions;

NOW, THEREFORE, for a valuable consideration, the receipt whereof is hereby acknowledged, WE, do hereby sell, assign, transfer, and set over unto the said Assignor, its successors and assigns, the full and exclusive right, title and interest in and to the aforesaid application for United States Letters Patent inclusive of any and all priority rights derived therefrom, and the invention therein disclosed, and in and to all Letters Patent and issues thereof which may be granted upon said application and in and to all Letters Patent which may be issued upon any substitutes, divisions, or continuations of said application, and in and to any and all Letters Patent which may be granted for said inventions in any foreign country or countries; the same to be held and enjoyed by the said Assignor for its own use and behoof, and for the use and behoof of its successors and assigns, to the full end of the term or terms for which said Letters Patent and reissues thereof may be granted as fully and entirely as the same would have been held and enjoyed by them had this assignment and sale not been made;

AND WE, hereby agree to execute, upon request, any and all further papers which may be necessary or desirable to enable the said Assignor, its successors and assigns, to file and prosecute said application, and any and all substitutes, divisions, or continuations thereof, and any and all reissues of the Letters Patent granted upon said application, or upon any substitutes, divisions, or continuations thereof, and any and all applications for foreign Letters Patent on said invention; and WE, further agree to execute any and all further papers which may be necessary or desirable to vest or perfect the title of said Assignor, its successors and assigns, in and to said application and the inventions therein disclosed, and in and to any and all Letters Patent and reissues thereof, both United States and foreign, which may be granted upon said application, and any substitutes, divisions, or continuations thereof, and upon any foreign applications.

AND WE, hereby authorize and request The Commissioner of Patents to issue each and every Letters Patent to be granted upon the aforesaid application for United States Letters Patent, and upon any and all substitutes, divisions, and continuations of said application, and each and every reissue of said Letters Patent, to the said Assignor, its successors and assigns, as the assignee of the entire right, title and interest therein, in accordance with this assignment.

WITNESS my hand at <u>HUNG</u>	KONG
this <u>24</u> day of FEBRUARY	$,\frac{20073}{3003}$
	Chun Ho FAN
Witness:	
	Kwok Cheung TSANG
witness:	
Witness:	Kwok Cheung TSANG

PATENT REEL: 013837 FRAME: 0822



William Lap Keung CHOW

PATENT REEL: 013837 FRAME: 0823

RECORDED: 03/14/2003